

Willow Bohlen

Computer Science Student

Work Experience

Aug. 2021 -
Present

Resident Assistant

Heidelberg University, Tiffin, OH

- Supervised residents in gender-inclusive housing.
- Communicated and enforced campus procedures.

Aug. 2019 -
Present

Recording Engineer

Heidelberg University, Tiffin, OH

- Produced recordings of on-campus performances.
- Trained in use of professional audio equipment.

Sept. 2017 -
Jan. 2021

Data Processing Intern

COTSWORKS LLC, Highland Heights, OH

- Worked on implementing JobBOSS, a software suite for inventory and production management.
- Wrote internal documentation for software usage.
- Assisted with tracking inventory.

Education

Aug. 2019 -
May 2023

B.S. in Computer Science/Music Composition

Heidelberg University, Tiffin, OH

- 3.8 cumulative GPA, Honors Program

Aug. 2017
-May 2019

Excel TECC: Information Technology and Programming

Mayfield High School, Mayfield Village, OH

- 4.0 program GPA
- TestOut certifications: Desktop Pro, PC Pro

Activities

- Heidelberg Student Research Conference (Presenter 2022, 2023)
- Computer and Technology Club, 2022-Present
- Tau Mu Sigma Music Honorary, 2022-Present (Treasurer, 2023)
- Alpha Phi Tau Men's Fraternity, 2020-Present (President, 2023)
- Heidelberg Concert Choir, 2019-Present
- FIRST Tech Challenge, 2014-2017 (Lead Programmer)

Personal Info

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Phone

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LinkedIn

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Awards

Martin A. Reno Senior Scholar Prize in Computer Science

Heidelberg University, 2022

Silver Medalist in Interactive Application and Game Development

SkillsUSA Ohio State Championships, 2019

Eagle Scout

Boy Scouts of America, 2019

Skills

- C#
- Python
- MySQL
- Linux
- Java
- JavaScript
- Unity
- Arduino